

Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	Conditions
Peak Pulse Power Dissipation	P_PP	1,300	W	8/20µs, Per Fig. 3
Peak Pulse Current	Ipp	50	Α	8/20µs, Per Fig. 3
ESD Protection – Contact Discharge	V _{ESD_Contact}	±30	kV	Standard IEC 61000-4-2
ESD Protection – Air Discharge	V _{ESD_Air}	±30	kV	Standard IEC 61000-4-2
ESD Protection – Human Body Model	V _{ESD_HBM}	±16	kV	Standard IEC 61000-4-2

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Package Power Dissipation (Note 5)	P _D	350	mW
Thermal Resistance, Junction to Ambient (Note 5)	R _{0JA}	500	°C/W
Operating Temperature Range	TJ	-55 to +125	°C
Storage Temperature Range	T _{STG}	-65 to +150	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

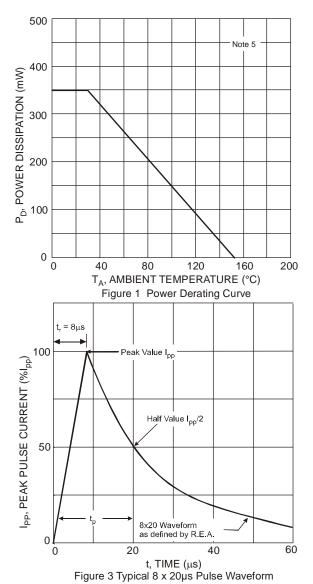
Characteristic	Symbol	Min	Тур	Max	Unit	Test Conditions
Reverse Working Voltage	V_{RWM}	_	_	14	V	_
Reverse Current (Note 6)	I_R	_	10	100	nA	$V_R = V_{RWM} = 14V$
Reverse Breakdown Voltage	V_{BR}	14.5	_	17.5	V	$I_R = 1mA$
		_	_	18		$I_{PP} = 1A, t_p = 8/20\mu s$
Reverse Clamping Voltage	V_{CL}	_	_	23	V	$I_{PP} = 30A$, $t_p = 8/20 \mu s$
		_	_	26		$I_{PP} = 50A$, $t_p = 8/20\mu s$
Capacitance	C _T	_	360	-	pF	$V_R = 0V$, $f = 1MHz$

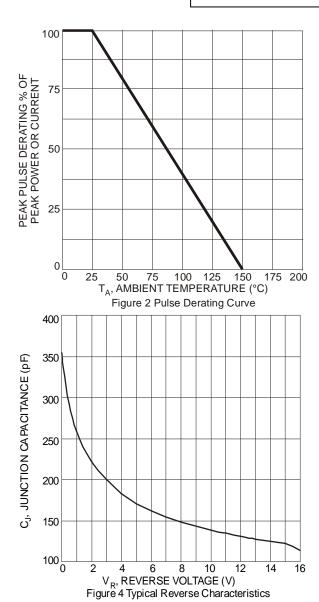
Notes:

^{5.} Device mounted on FR-4 PCB pad layout (2oz copper) as shown on Diodes, Inc. suggested pad layout AP02001, which can be found at http://www.diodes.com/datasheets/ap02001.pdf.

^{6.} Short duration pulse test used to minimize self-heating effect.





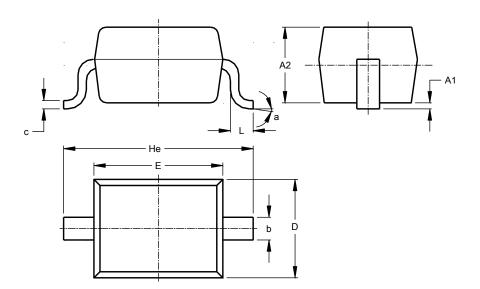




Package Outline Dimensions

Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.

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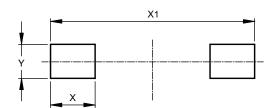


SOD323					
Dim	Min	Max	Тур		
A1		0.10	0.05		
A2	1.00	1.10	1.05		
b	0.25	0.35	0.30		
С	0.10	0.15	0.11		
D	1.20	1.40	1.30		
Е	1.60	1.80	1.70		
He	2.30	2.70	2.50		
L	0.20	0.40	0.30		
а	0°	8°	_		
All Dimensions in mm					

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.

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Dimensions	Value (in mm)
Х	0.590
X1	2.700
Υ	0.450



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